

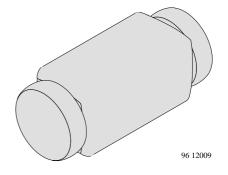
Silicon PIN Diodes

Features

• Wide frequency range 10 MHz to 1 GHz

Applications

Current controlled HF resistance in adjustable attenuators



Absolute Maximum Ratings

 $T_j = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Reverse voltage			V_R	30	V
Forward current			I_{F}	50	mA
Junction temperature			T_j	125	°C
Storage temperature range			T _{stg}	−55+125	°C

Maximum Thermal Resistance

 $T_j = 25^{\circ}C$

	Parameter	Test Conditions		Value	Unit	
Junction ambient on I		on PC board 50mmx50mmx1.6mm	R_{thJA}	500	K/W	

Characteristics

 $T_j = 25\,^{\circ}C$

Parameter	Test Conditions	Type	Symbol	Min	Тур	Max	Unit
Forward voltage	I _F =20mA		V_{F}			1	V
Reverse current	$V_R=30 \text{ V}$		I_R			50	nA
Diode capacitance	f=100MHz, V _R =0		C_{D}			0.5	pF
Differential forward resistance	f=100MHz, I _F =1.5mA		r_{f}			50	Ω
Reverse impedance	f=100MHz, V _R =0	BA979	Z_{Γ}	5			kΩ
		BA979S	z_{r}	9			kΩ
Minority carrier lifetime	I _F =10mA, I _R =10mA		τ		4		μs



Typical Characteristics ($T_j = 25$ °C unless otherwise specified)

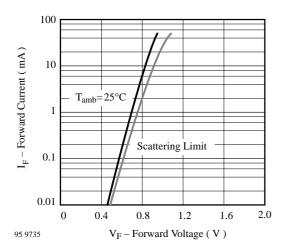


Figure 1. Forward Current vs. Forward Voltage

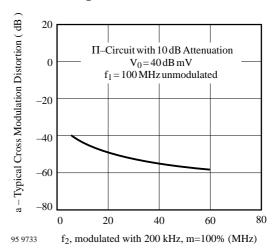
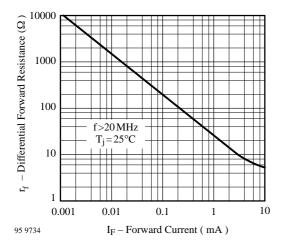


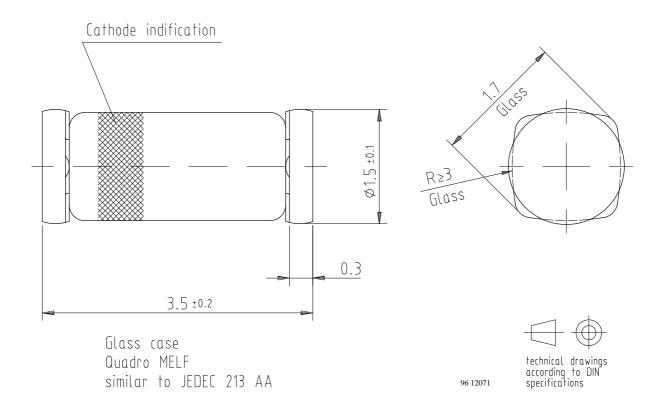
Figure 3. Typ. Cross Modulation Distortion vs. Frequency f2



 $Figure\ 2.\ Differential\ Forward\ Resistance\ vs.\ Forward\ Current$



Dimensions in mm



BA979.BA979S



Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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